渝

深圳市帝国科技有限公司

SHENZHEN DIGUO TECHONLOGY CO., LTD

规格书

		Sp	eci <mark>ficati</mark>	on	
	CUSTOME	R 客户:			_
	Nam	e 名称:	声表面谐 <mark>振器</mark> R433.92M		_
	Mode	al 型号:			_
	Packag	e 封装:	SMI)3030mm	
	审核结果	客戶簽名	日期	備注	
	Audit results	SIGNATURE	DATE	REMARK	
	合格 ACCEPT				
	不合格 REJECT				
			2-1		
上.桂	: 刘玖武	-	审核:		(公章)

帝国科技 http://www.dgkjly.com Tel:0755-27881119 QQ: 921977998

1. Scope

This specification shall cover the characteristics of 1-port SAW resonator with R433.92 used for remote-control security.

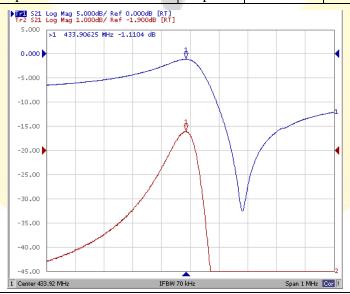
2. Electrical Specification

2.1 Maximum Rating

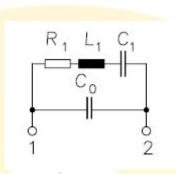
DC Voltage VDC	10V
AC Voltage Vpp	10V 50Hz/60Hz
Operation temperature	-40°C to +85°C
Storage temperature	-45°C to +85°C
Source Power	0dBm

2.2 Electronic Characteristics

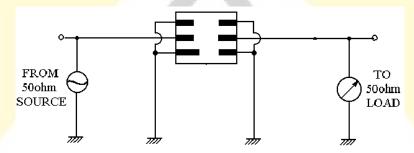
Item		Unites	Minimum	Typical	Maximum	
Center Freque	ency	MHz	433.845	433.92	433.995	
Insertion Loss	5	dB		1.4		
Ovality Facto	Unload Q		8000	12800		
Quality Facto	50Ω Loaded Q		1000	2000		
Temperature	Turnover Temperature	$^{\circ}\mathbb{C}$	10	25	40	
Stability	Freq.temp.Coefficient	ppm/℃		0.032		
Frequency Ag	ging	ppm/yr		<±10		
DC. Insulation	n Resistance	ΜΩ	1.0			
RF	Motional Resistance R1	Ω		17	26	
Equivalent	ent Motional Inductance L1			70.743		
RLC Model	Motional Capacitance C1	fF		1.9018		
Transducer St	atic Capacitance C0	pF		2.0		



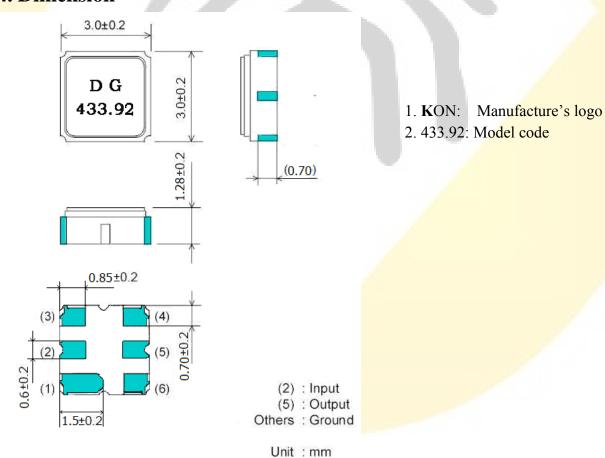
2.3 Equivalent LC Model



3. Test Circuit



4. Dimension



5. Environment Characteristic

5-1 Thermal Shock:

The components shall remain within the electrical specifications after being kept at the condition of heat cycle conditions: TA=-40°C±3°C, TB=85°C±2°C, t1=t2=30min, switch time \(\le 3\text{min & cycle time : 100 times, recovery time: 2h \(\pm 0.5\text{h}. \)

5-2 Resistance to solder heat

Submerge the device terminals into the solder bath at $260^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 10 ± 1 sec. Then release the device into the room conditions for 4 hours. It shall meet the specifications in 2.2.

5-3 Solder ability

Submerge the device terminals into the solder bath at 245° C $\pm 5^{\circ}$ C for 5s, More than 95% area of the soldering pad must be covered with new solder. It shall meet the specifications in 2.2

5-4 The Temperature Storage:

- 5.3.1 High Temperature Storage: The components shall remain within the electrical specifications after being kept at the $85^{\circ}\text{C} \pm 2^{\circ}\text{C}$ for $96\text{h} \pm 4\text{h}$, recovery time: $2\text{h} \pm 0.5\text{h}$.
- 5.3.2 Low Temperature Storage: The components shall remain within the electrical specifications after being kept at the $-40^{\circ}\text{C} \pm 3^{\circ}\text{C}$ for 96h±4h, recovery time: 2h±0.5h.

5-5 Humidity test:

The components shall remain within the electrical specifications after being kept at the condition of ambient temperature $60^{\circ}\text{C} \pm 2^{\circ}\text{C}$, and $90 \sim 96\%$ RH for $96\text{h} \pm 4\text{h}$.

5-6 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1m for 3 times. The resonator shall fulfill the specifications in 2.2.

5-7 Vibration

Subject the device to the vibration for 2 hour each in X, Y and Z axes with the amplitude of 1.5 mm at 10 to 55 Hz. The resonator shall fulfill the specifications in 2.2.

6. Remark

6.1 Static voltage

Static voltage between signal load & ground may cause deterioration &destruction of the component. Please avoid static voltage.

6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

SAW RESONATOR

6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.

7. Packing

7.1 Dimensions

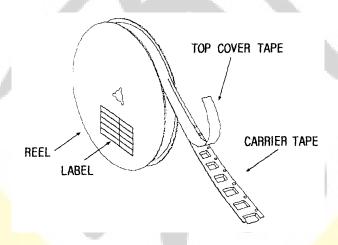
- (1) Carrier Tape: Figure 1
- (2) Reel: Figure 2
- (3) The product shall be packed properly not to be damaged during transportation and storage.

7.2 Reeling Quantity

1000 pcs/reel 13" 3000 pcs/reel

7.3 Taping Structure

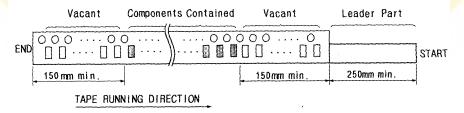
(1) The tape shall be wound around the reel in the direction shown below.



(2) Label

Device Name	
User Product Name	
Quantity	
Lot No.	

(3) Leader part and vacant position specifications.



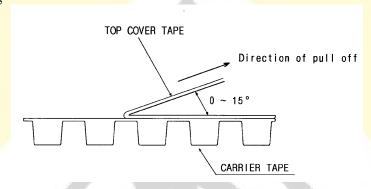
SAW RESONATOR

DG-R433.92M SMD-3030mm

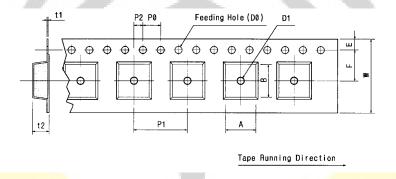
http://www.dgkjly.com Lel:0755-27881119 QQ: 921977998 E-mail:dgkjly@163.com

8. Tape Specifications

- 8.1 Tensile Strength of Carrier Tape: 4.4N/mm width
- 8.2 Top Cover Tape Adhesion (See the below figure)
 - (1) pull off angle: 0~15° (2) speed: 300mm/min.
 - (3) force: 20~70g



[Figure 1] Carrier Tape Dimensions



[Unit: mm]

W	F	Е	P0	P1	P2	D0	D1	t1	t2	Α	В
12.0	5.5	1.75	4.0	4.0	2.0	Ø1.5	Ø1.0	0.3	1.25	3.3±	3.3±
± 0.3	± 0.05	± 0.1	± 0.1	± 0.1	± 0.05	±0.1	± 0.25	± 0.05	± 0.1	0.1	0.1

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[Figure 2] Reel Dimensions

